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				DIQ-SPE-140(00) g.12,2022
То :				
	CUSTOMER	R'S PRODUCT NAM	E	
	ASDI P	RODUCT NAME:		
	ASCM45	532F2SF-SERIES		
RECEIPT CONFIRM			CONDITIONAL CO	MOTAIT
UNCOND	ITIONAL CONSENT		CONDITIONAL CO	JNSENT
	APPROVED		CHECKED	
ASDI SIGNATURE				
_ :	APPROVED	CHECKED	PREPARED	
	Xianglong Li	Liang Wang	Jiayin Cai	



REV.	DATE	DESCRIPTION	APPROVED	CHECKED	PREPARED
00	Aug.12,2022	New release	Xianglong Li	Liang Wang	Jiayin Cai

## **CAUTION WHEN HANDLING**

Before use the products, please read this specification.

## **CAUTION FOR SAFETY USING**

When use the products, be careful to mentioned below for safety using.

## **CAUTION**

\*The product should be used within 12 monthes.

Focus on the storage conditions.

Solderability may become weak if it exceeds the period.

\*Do not use and store the product in condition of gas corrosion

(Salt, Acid, Alkaline).

\*The products must be preheated before soldering.

The operating temperature including self-generated heat must be within '-40° ~+125° C

\*Rework by soldering iron;Please keep the mentioned conditions in this specification.

\*In case of insert P.C. Board on chassis, do not add mechanical stress to the product.

\*Be careful to arrange of non-magnetic field type inductors.

The error may be caused by magnetic field coupling.

\*In case handle the products, please use wrist strap for ground static discharge on human body.

The product keeps away from magnet or magnetized things.

\*Do not use the product beyond the mentioned conditions in this specification.

\*About an application

The products listed on this specification sheet are intended for use in general electronic equipment

(AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

\*The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused

by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

1)Aerospace/Aviation equipment
2)Military equipment
3)Seabed equipment
4)Safety equipment
5)Medical equipment

6)Transportation control equipment
7)Power-generation control equipment
which directly endanger human life
8)Atomic energy-related equipment
9)Other applications that are not

considered general-purpose applications

If you intend to use the products in the following applications, please contact our sales office

Transportation equipment (cars, electric trains, ships, etc.), Public information-processing equipment, Electric heating apparatus / burning equipment, Disaster prevention/crime prevention equipment

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.

Xiamen ASDI Electronics Co., Ltd.

DWG.No. ASDIQ-SPE-140(00)

**ISSUE** 

CUSTOMER	ASDI PART No.	CUSTOMER'S DWG NO.
	ASCM4532F2SF-SERIES	

### 1.INDEX

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3.Part Numbering	Please see (3)	3/7
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### 2.Manufacturing Location

China

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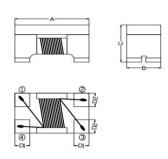
### (1)Features

- 1. High common mode impedance at high frequency cause excellent noise suppression performance.
- 2. ASCM4532F2SF series realizes small size and low profile. 4.5x3.2x2.8 mm.
- 3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

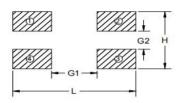




### (2)Dimensions



### Recommended PC Board Pattern



PC board should be designed so that products can prevent damage from mechanical stress when warping the board. Products shall be positioned in the sideway direction against the mechanical stress to prevent failure.

Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	L(mm)	H(mm)	G1(mm)	G2(mm)
4532F2SF	4.5±0.2	3.2±0.2	2.8±0.2	1.0±0.1	1.2±0.1	4.8	3.8	2.5	0.7

### (3)Part Numbering

**ASCM** 4532 900 20 G A: Series В

B: Dimension

C: Material Ferrite

2=2 lines S=Shielded , N=Unshielded D: Number of Lines

E: Type

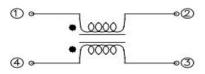
900=90Ω

F: Lead free type G: Impedance H: Packaging I: Rated Current T=Taping and Reel 20=2000mA

### (4)Electrical Schematics

ASDI Part Number	Common mode Impedance $(\Omega)$	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA)	Rated Volt. (Vdc)	Withstand Volt. (Vdc)	IR (Ω) min.
ASCM4532F2SF-900T20	90±25%	100	0.05	2000	50	125	10M
ASCM4532F2SF-601T15	600±25%	100	0.24	1500	50	125	10M
ASCM4532F2SF-801T10	800±25%	100	0.24	1000	50	125	10M
ASCM4532F2SF-102T10	1000±25%	100	0.24	1000	50	125	10M

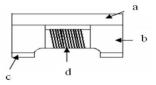
#### (5)Schematic Diagram



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### (6)Materials

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
С	Termination	Tin Pb Free
d	Wire	Enameled Copper Wire



### (7)Reliability Tests

No.	Test item	Performance	Test details
		Electrical Characteristics Test	
1	Z(common mode)		HP-4291A+HP-16092A
2	DCR		HP-4338B
3	I.R.	Refer to standard electrical characteristics list.	Agilent4339
4	Rated Current		
5	Operating temperature	-40°C~+125°C	
6	Storage temperature	-40 $^{\circ}\!$	
7	Temperature Rise Test	Rated Current < 1A ∆T 20 °C Max Rated Current ≧ 1A ∆T 40 °C Max	Applied the allowed DC current.     Temperature measured by digital surface thermometer.
		Mechanical Performance Test	
8	Solderability Test	More than 95% of terminal electrode should be covered with solder	Preheat:150 °C,60 sec Solder:Sn99.5% -Cu0.5% . Temperature:245 ±5 °C . Fluxforleadfree:Rosin.9.5% . Diptime:4±1 sec . Depth:completelycoverthetermination
9	Solder Heat Resistance		Temperature (s) Temperature ramp/immersion and emersion rate (sydes)  260 ± 5 (solder temp) 10 ± 1 25mm/s ± 6 mm/s 1  Depth: completely cover the termination
10	Terminal Strength	Appearance: No damage. Impedance: within±15% of initial value RDC: within±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force (>0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.  Tadius 0.5 mm  DUT  Wide  Wide  Wide  Whitekness

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No.	Test item	Performance	Test details
		Reliability Test	
11	Life Test		Preconditioning:Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature: 125±2°C (Bead) Temperature: 85±2°C (Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs
12	Thermal Shock		Preconditioning:Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Step1: -40±2°C 30±5min Step2: 25±2°C ≦0.5min Step3: 105±2°C 30±5min Number of cycles: 500 Measured at room fempraturc after placing for 24±2 hrs
13	Humidity Resistance Test	Appearance:No damage.     Impedance:within ±25% of initial value.     No disconnection or short circuit.	Preconditioning:Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2% R.H, Temperature: 85℃±2℃ Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
14	Vibration Test		Preconditioning:Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).

|--|

# (8)Soldering and Mounting 8-1,Soldering

Mildly activated rosin fluxes are preferred. ASDI terminations are suitable for all wave and reflow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

### 8-1.1,Lead Free Solder re-flow:

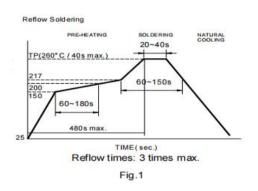
Recommended temperature profiles for re-flow soldering in Figure 1.

### 8-1.2, Solder Wave:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

#### Note:

- ·Preheat circuit and products to 150℃
- ·Never contact the ceramic with the iron tip
- ·Use a 20 watt soldering iron with tip diameter of 1.0mm
- ·355°C tip temperature (max)
- ·1.0mm tip diameter (max)



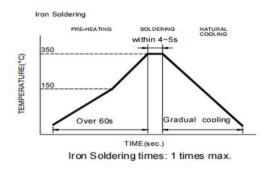
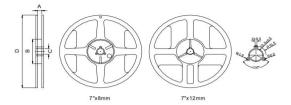


Fig.2

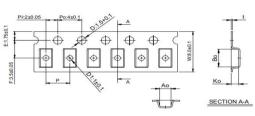
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## (9)Packaging Information 9-1,Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x12mm	13.5±0.5	60±2	13.5±0.5	178±2

### 9-2, Tape Dimension

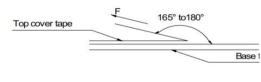


Series	size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
ASCM4532F2SF	4532	4.90±0.1	3.60±0.1	3.00±0.1	8.0±0.1	0.26±0.05

### 9-3, Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
ASCM4532F2SF	500	2500	12500	25000

### 9-4, Tearing Off Force



e for tearing off cover tape is 15 to 60 grams ow direction under the following conditions.

Room Temp.	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

### (10)Note

Storage Conditions

- To maintain the solderability of terminal electrodes:
- 1. ASDI products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
  2. Temperature and humidity conditions: Temperature: 5 to 30deg.C, Humidity: 75% Max.
  3. Recommended products should be used within 12 months form the time of delivery.
  4. The packaging material should be kept where no chlorine or sulfur exists in the air.

  Transportation
  4. Particular the build be lead to the control of the co

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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## 单击下面可查看定价,库存,交付和生命周期等信息

### >>ASDI